

50323-XXX X Y-XXX
Q'ty OF CKT

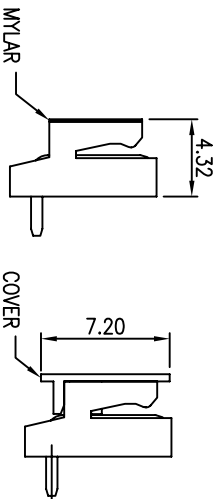
Packing _____
0:TAPE&REEL
4:TAPE&REEL WITH MYLAR
7:TAPE&REEL WITH COVER

PLATING :
N:MATT TIN
1:GOLD FLASH OVER ALL

Others	Housing color	HALOGEN FREE	DIM D
001	BLACK	HF	2.2
002	BLACK	HF	1.2

- NOTES:
- MATERIAL:
1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP., UL94V-0;
 - FINISH:
1.2 CONTACT: COPPER ALLOY
2.1 CONTACT:50u" MIN. NICKEL UNDERPLATING OVERALL,
N: 100u" MIN. MATT TIN PLATING OVERALL,
1: GOLD FLASH OVERALL,
 - SPEC. PLS. REFER TO PS-50323-xxxxx-xxx.
 - PACKAGE PLS. REFER TO 88334-XXXX-TRP

CKT	DIM A	DIM B	DIM C
2	2.5	5.4	7.5
3	5.0	7.9	10.0
4	7.5	10.4	12.5
5	10.0	12.9	15.0
6	12.5	15.4	17.5
7	15.0	17.9	20.0
8	17.5	20.4	22.5
9	20.0	22.9	25.0
10	22.5	25.4	27.5
11	25.0	27.9	30.0
12	27.5	30.4	32.5
13	30.0	32.9	35.0
14	32.5	35.4	37.5
15	35.0	37.9	40.0



<p>一般公差</p> <p>TOLERANCES</p> <p>X ±0.6 XX ±0.15</p> <p>Y ±0.25 ZXX ±0.1</p> <p>ANGLES 45°</p>		<p>宏致電子股份有限公司</p> <p>Aces Electronic Co.,Ltd.</p>	
<p>檢驗尺寸標示</p> <p>SYMBOLS</p> <p>CLASSIFICATION DIMENSION</p> <p>MARK IS CRITICAL DIM.</p> <p>MARK IS MAJOR DIM.</p> <p>表面處理 (FINISH)</p>	<p>品名 (TITLE)</p> <p>2.5mm W-1-B WAFER</p> <p>R/A T/H TYPE</p> <p>圖號 (DRAWING NO)</p> <p>50323-XXXXX-XXX</p> <p>比例 (SCALE)</p> <p>5:1</p>	<p>製圖 (DRA)</p> <p>08/10/14</p> <p>審核 (CHKD)</p> <p>SAM</p> <p>核准 (APPD)</p> <p>JASON</p>	<p>ROGER</p> <p>SIZE</p> <p>A4</p> <p>REV</p> <p>B</p>